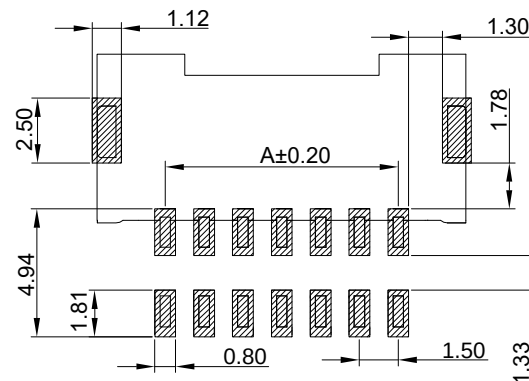
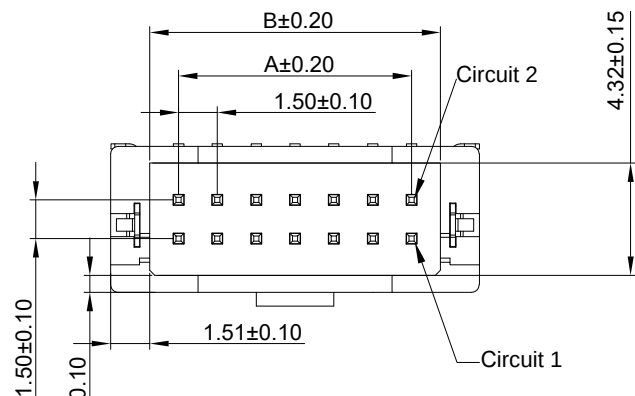
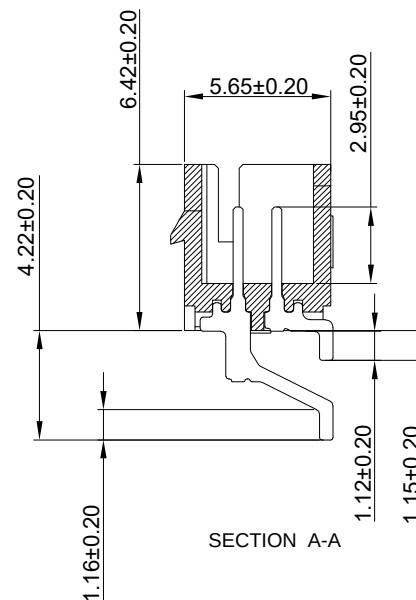
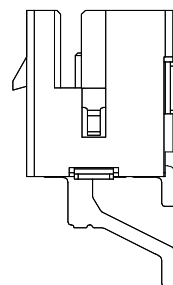


修订 REV	标记 MARK	修改摘要 REVISION DESCRIPTION	签名 SIGNATURE	日期 DATE
A0		NEW RELEASE	WANG	2023-09-25



PCB LAYOUT



SECTION A-A

Ordering Information & Dimensions

Circuits	Dimensions(mm)		
	A	B	C
2x2P	1.50	3.72	6.74
2x3P	3.00	5.22	8.24
2x4P	4.50	6.72	9.74
2x5P	6.00	8.22	11.24
2x6P	7.50	9.72	12.74
2x7P	9.00	11.22	14.24
2x8P	10.50	12.72	15.74
2x9P	12.00	14.22	17.24
2x10P	13.50	15.72	18.74
2x11P	15.00	17.22	20.24
2x12P	16.50	18.72	21.74
2x13P	18.00	20.22	23.24
2x14P	19.50	21.72	24.74
2x15P	21.00	23.22	26.24
2x16P	22.50	24.72	27.74
2x17P	24.00	26.22	29.24
2x18P	25.50	27.72	30.74
2x19P	27.00	29.22	32.24
2x20P	28.50	30.72	33.74

SPECIFICATIONS:

Current Rating: 2A AC,DC
Voltage Rating: 250V AC,DC
Temperature Range: -25°C ~ +85°C
Contact Resistance: 20mΩ Max.
Insulation Resistance: 500MΩ Min.
Withstanding Voltage: 500V AC/minute
Pin Material: Brass/Tin over Nickel
Solder Tabs: Brass/Tin over Nickel
Material: LCP,UL94V-0(Beige)



深圳市华德共创科技有限公司

Shenzhen Huade co-create Technology Co.,LTD

TEL : 0755-27129737 FAX : 0755-29940187

-TOLERANCES- UNLESS OTHERWISE SPECIFIED 公差参数表						TITLE: 1.50mm Pitch 产品名称: 90° Wafer			
X.X	±0.30	X.X°	±3°	APPD: 核准:	XIE	PART NO: 产品编号: HDGC1508WRA-S-2xXP			
X.XX	±0.30	X.XX°	±2°	CHECK: 校对:	WANG	DATE	SCALE	UNIT	CODE NUMBER
X.XXX	±0.10	X.XXX°	±1°	DRAW: 绘图:	WANG	2023-09-25	1:1	mm	A001